

ATLAS Inner Detector

J. Beyer – ATLAS-SCT

Max Planck Institut für Physik

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IMPRS Workshop



MAX-PLANCK-GESELLSCHAFT



Max-Planck-Institut für Physik
(Werner-Heisenberg-Institut)

Layout



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Overview

Inner Detector


- Pixel Detector
- Strip Detector
- Transition Radiation Tracker

Conclusion

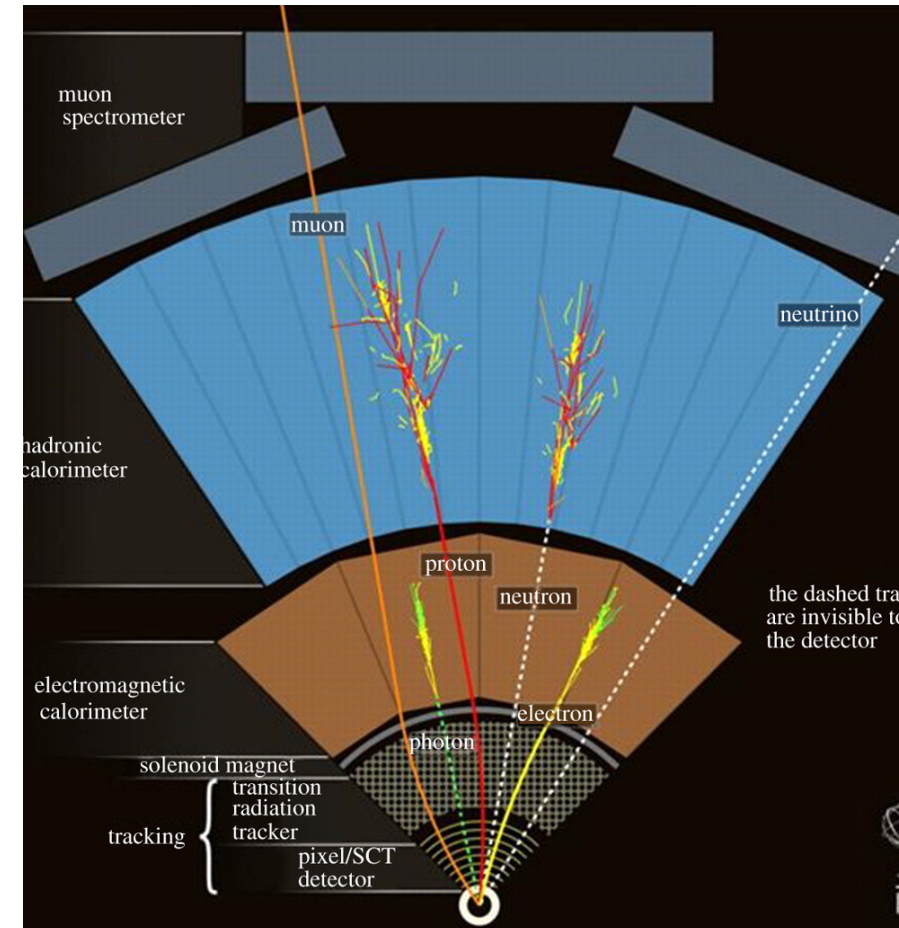
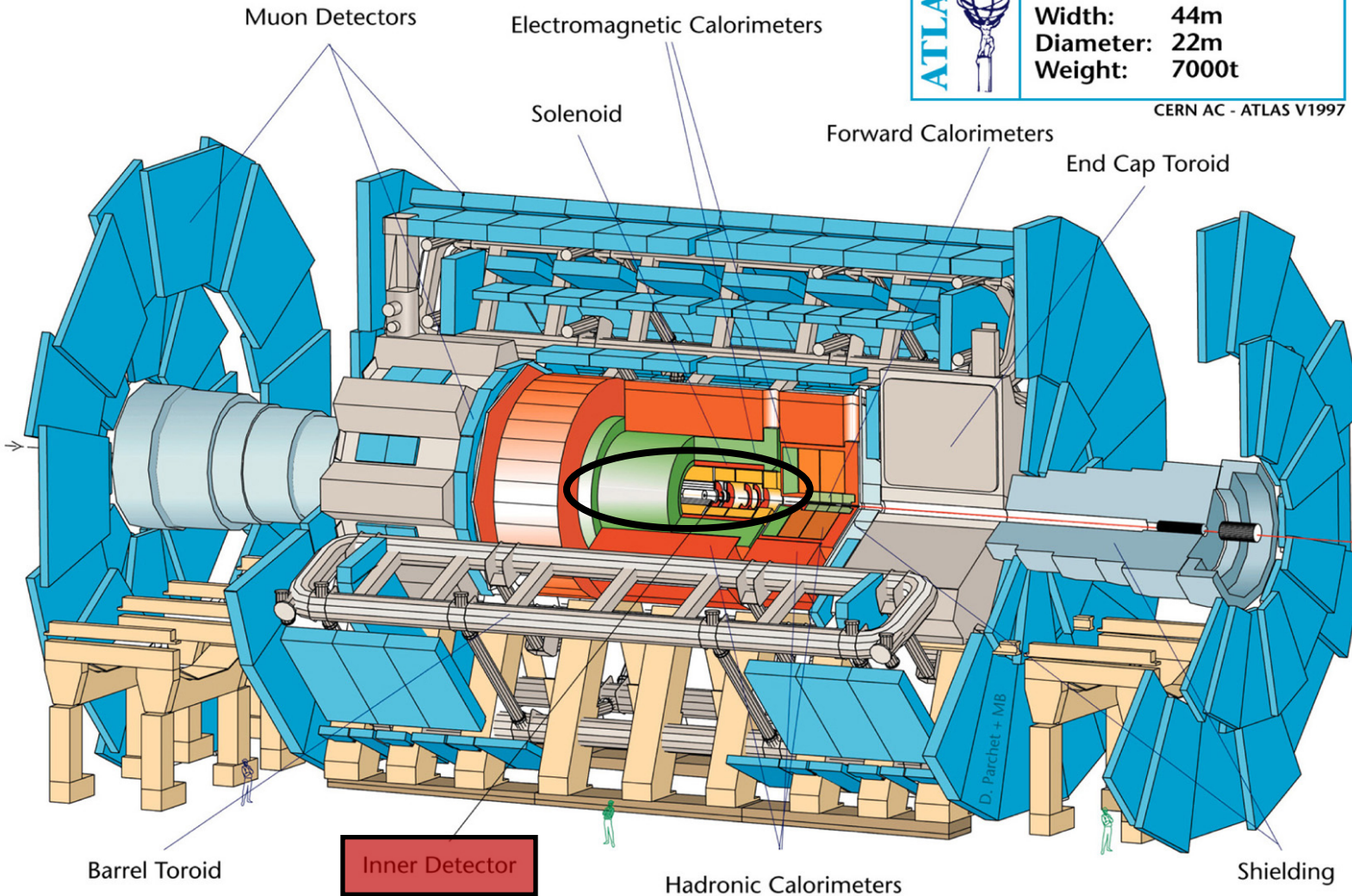
ATLAS Detector



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	Detector characteristics	
	Width:	44m
	Diameter:	22m
	Weight:	7000t

CERN AC - ATLAS V1997

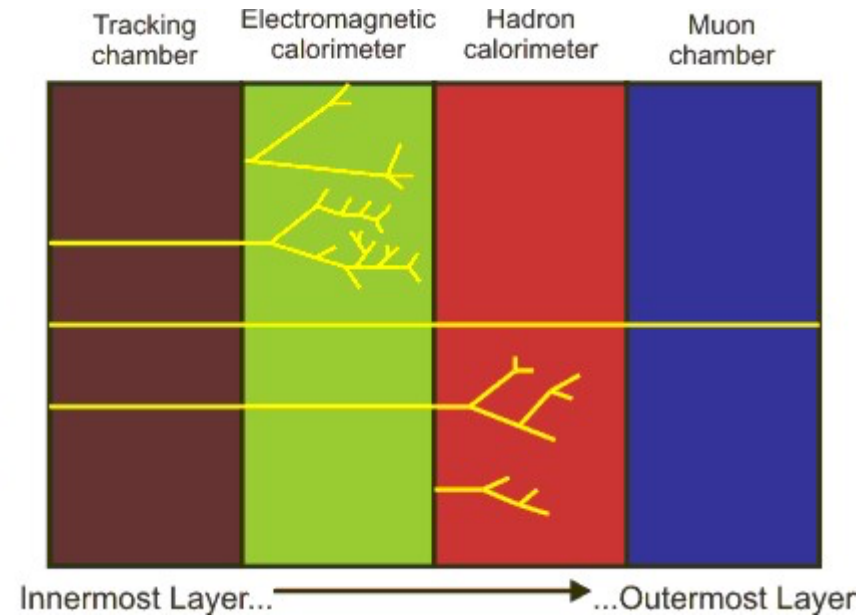
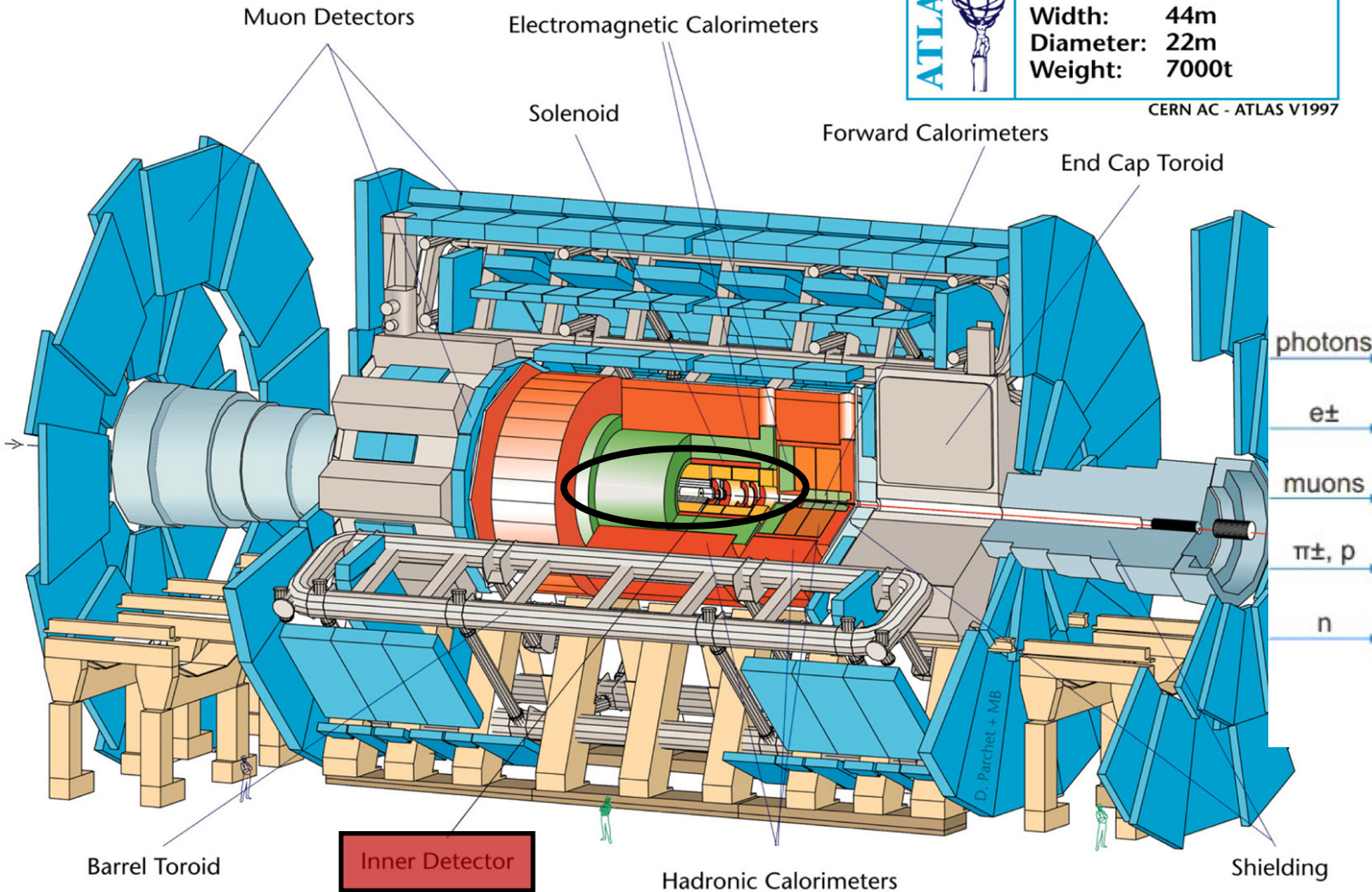


ATLAS Detector

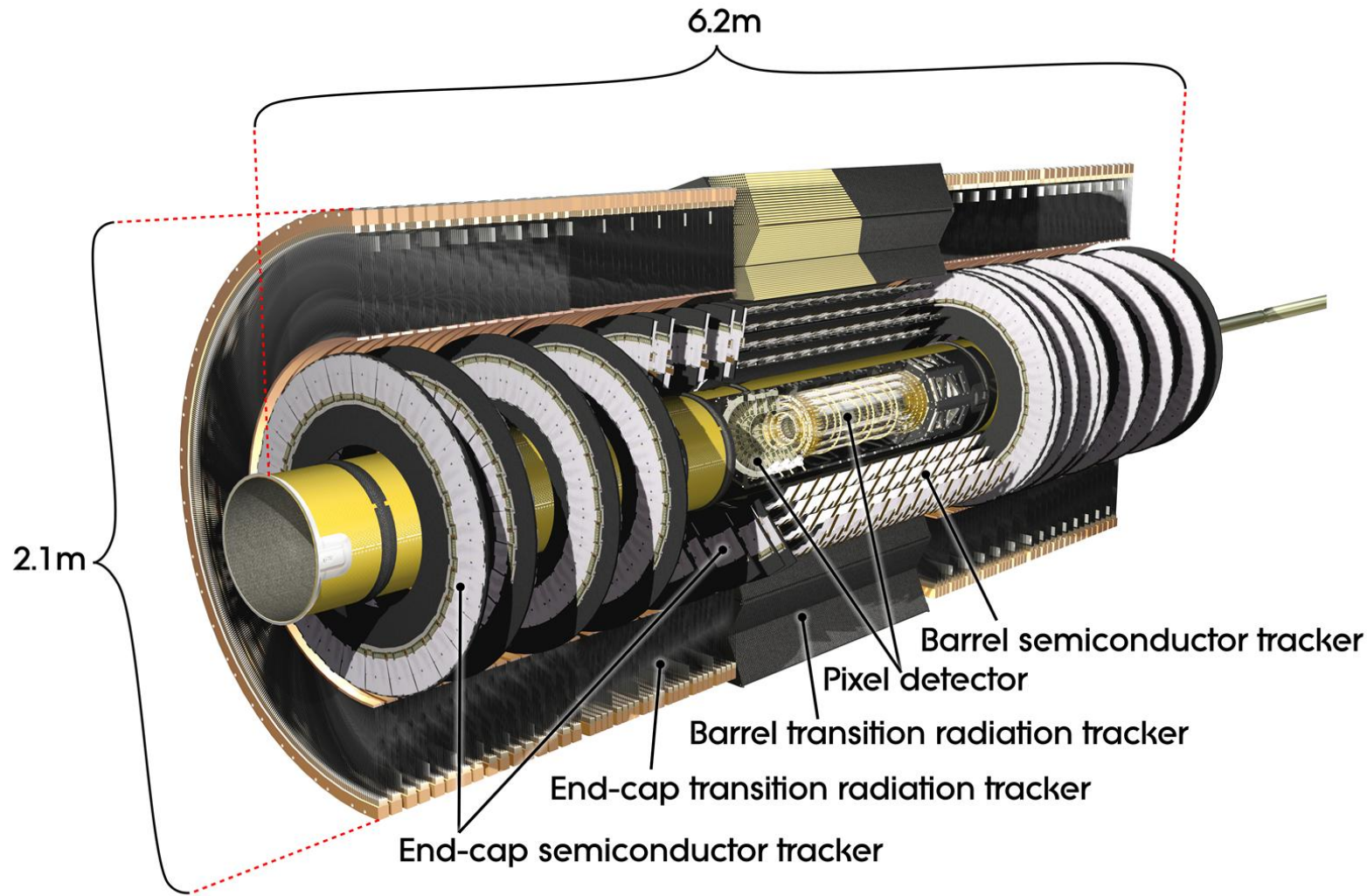


Detector characteristics
Width: 44m
Diameter: 22m
Weight: 7000t

CERN AC - ATLAS V1997



ATLAS Inner Detector



Inner Detector:

- innermost part of ATLAS
- situated in a 2T solenoidal magnetic field
- barrel and disk regions
 - hermetically coverage
 - perpendicular hits

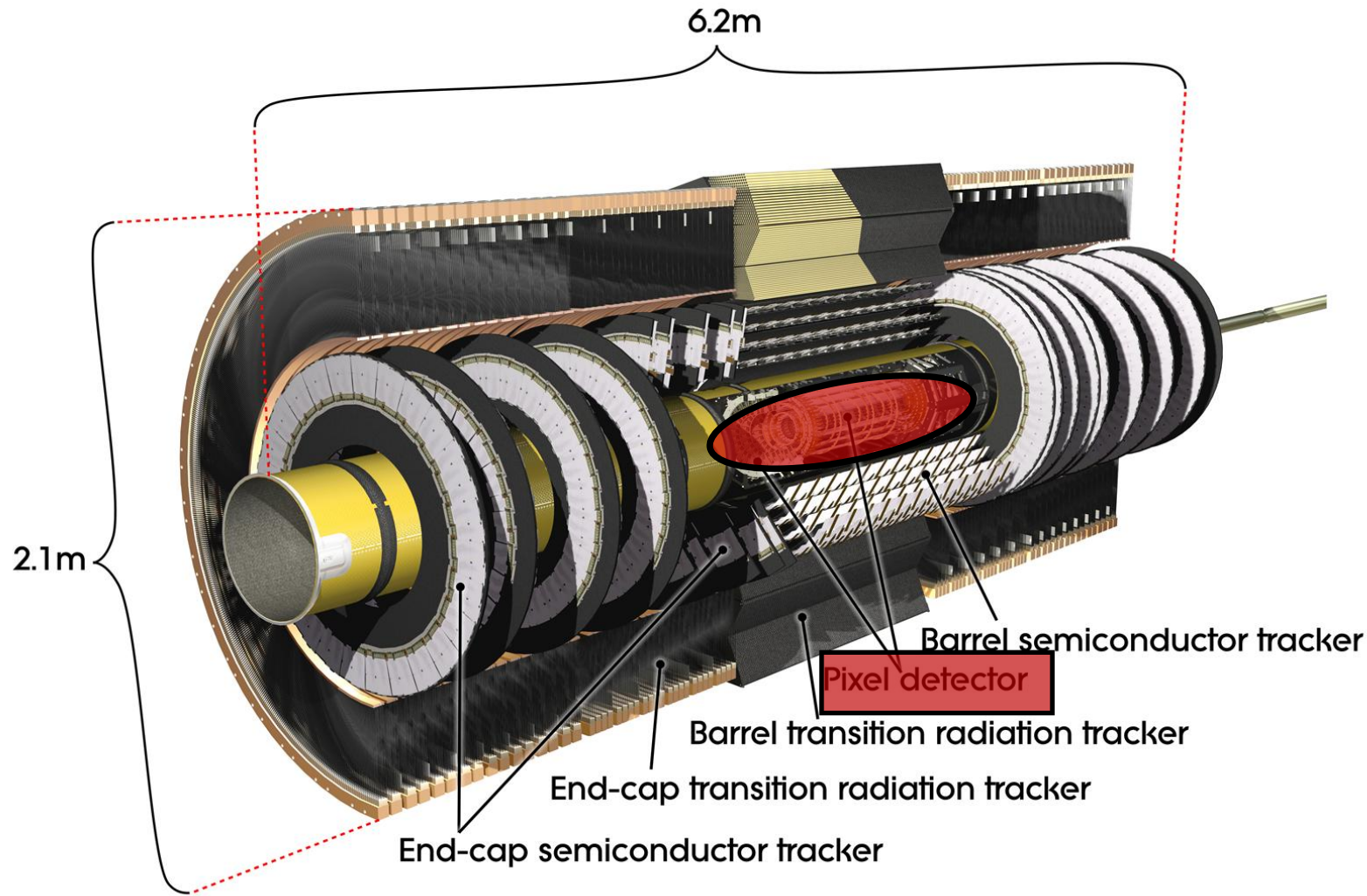
Function:

- track reconstruction of charged particles
- momentum reconstruction
- vertex finding / b-tagging
- particle identification

Components:

- Pixel Detector (PD/PIXEL)
 - 4 space-points
- Strip Detector (SCT)
 - 4 space-points
- Transition Radiation Tracker (TRT)
 - 36 space-points

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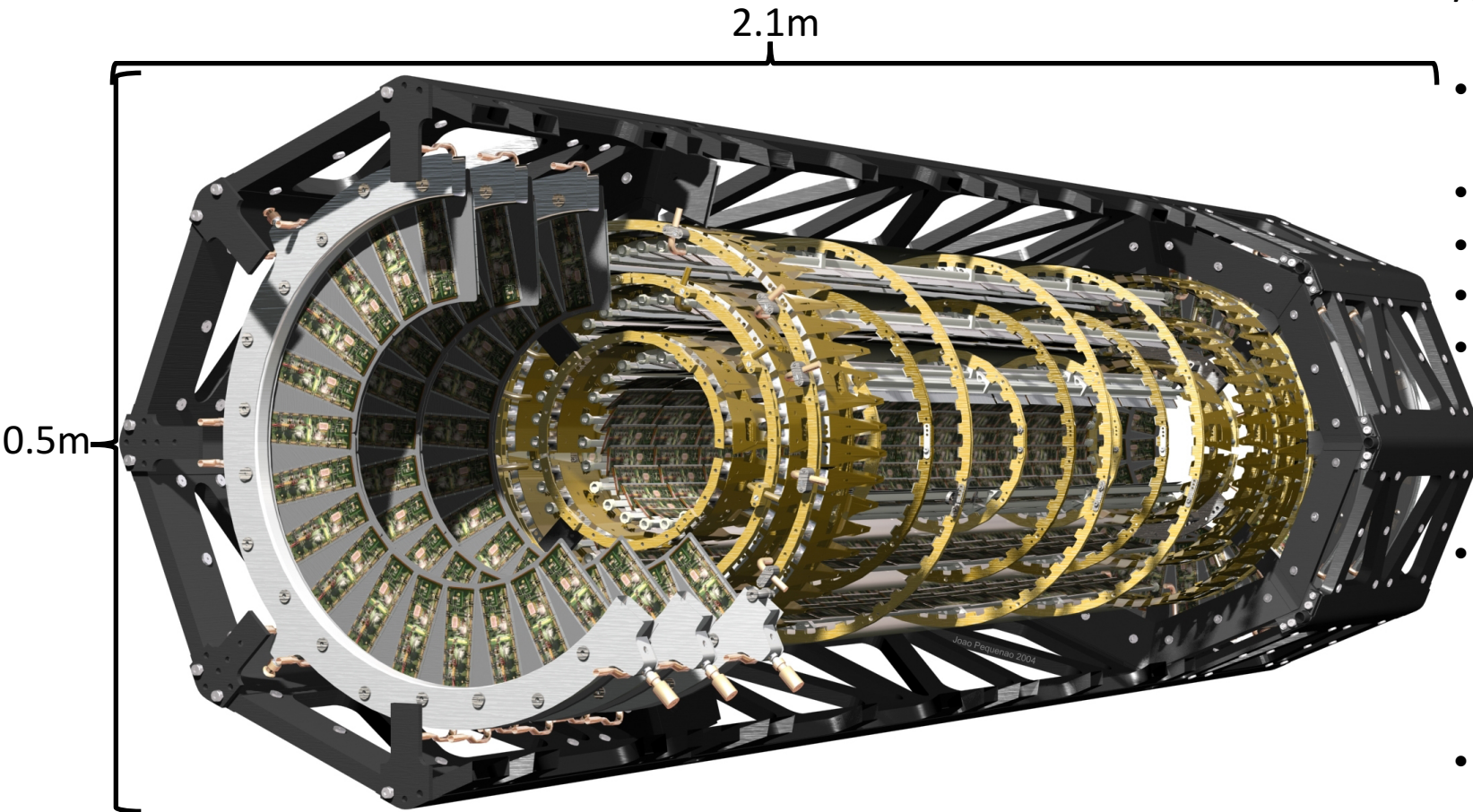
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ATLAS Pixel Detector



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ATLAS Pixel Detector:



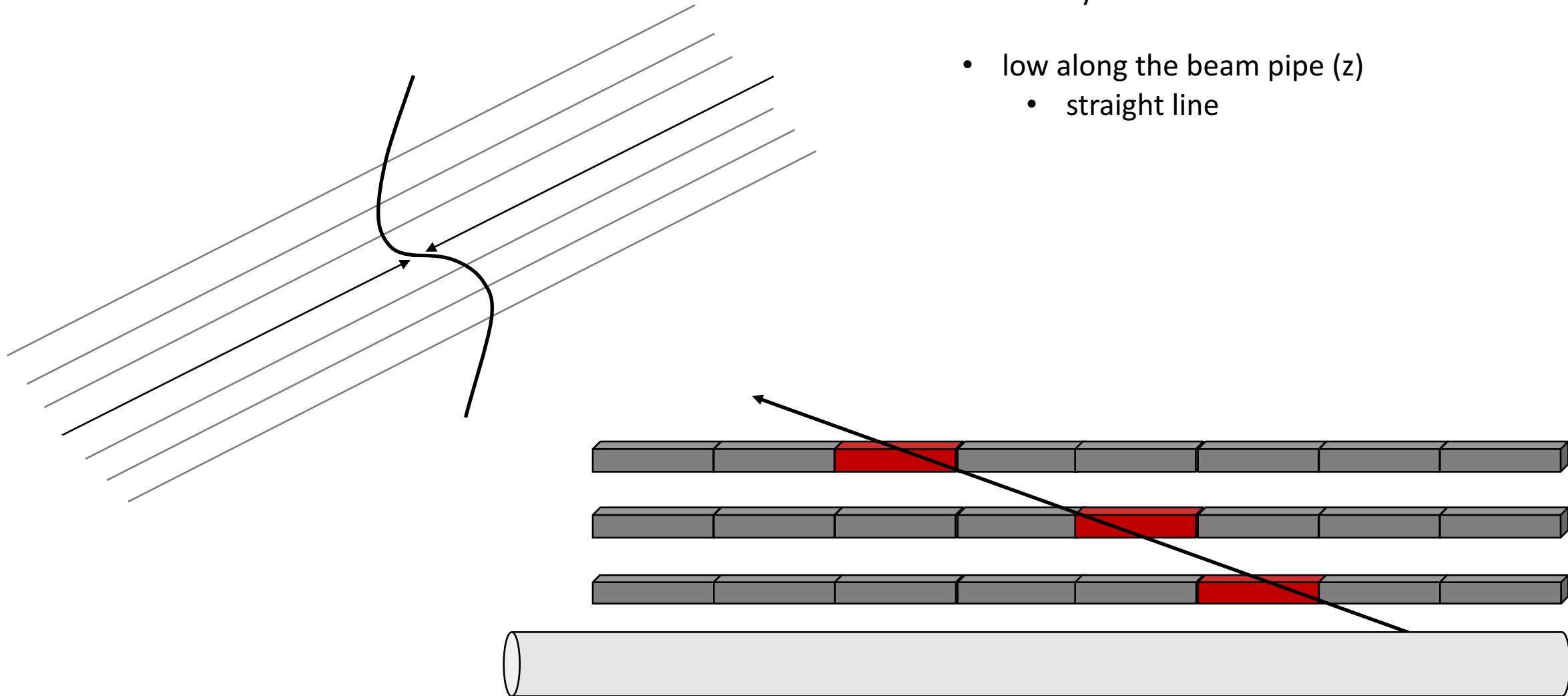
- originally 3 barrel layers (PIXEL)
 - Insertable B-Layer is #4
- 3 disks per side
- hybrid pixel detector modules
- 80.4 (+24.1)M channels
- 10 μm resolution in $R\phi$ and 110 (72) μm in z
 - given by pixel cell size
- needs to cope with highest
 - track density \rightarrow high granularity
 - rate \rightarrow precise timing
- crucial for
 - impact parameter resolution
 - b-tagging

Excursion: Resolution

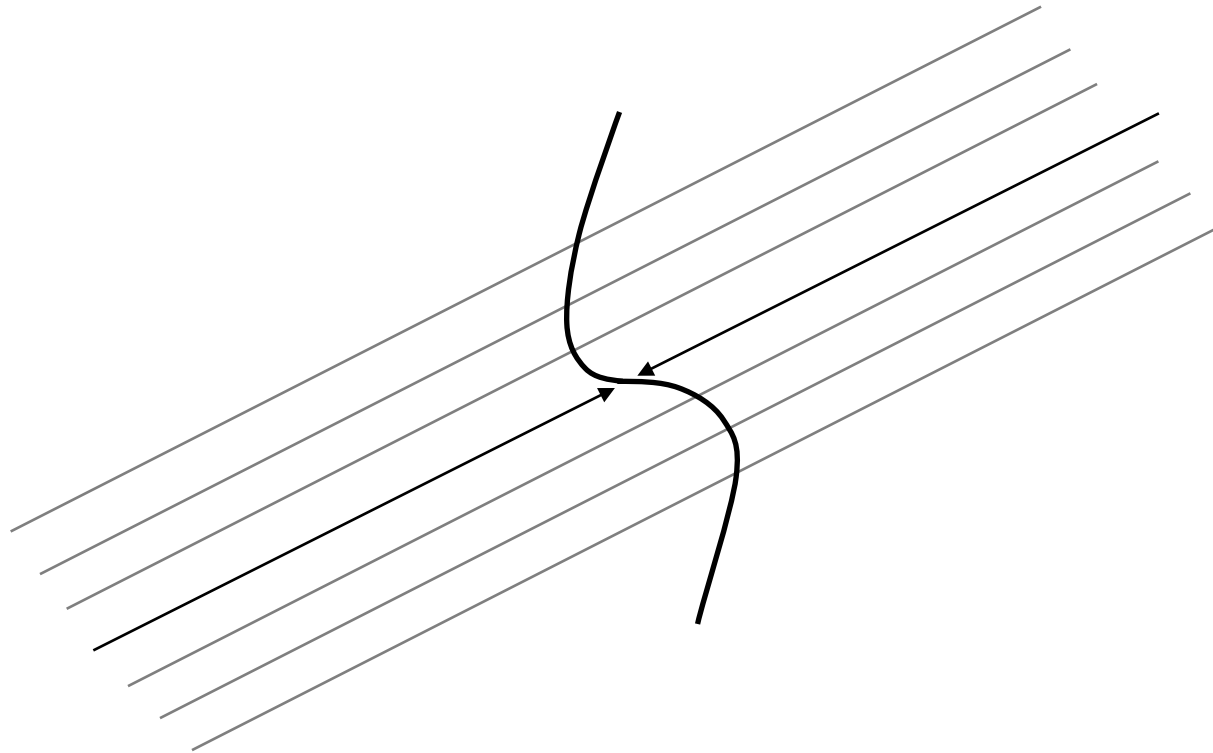


Necessary Resolution:

- low along the beam pipe (z)
 - straight line

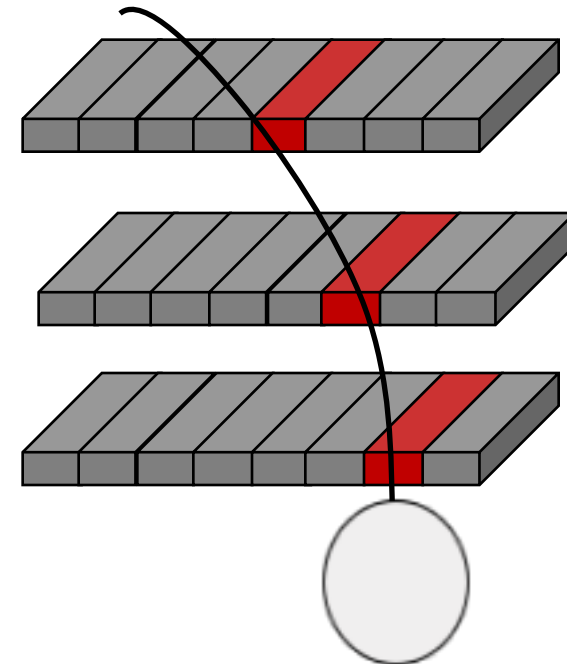


Excursion: Resolution



Necessary Resolution:

- low along the beam pipe (z)
 - straight line
- high in bended direction ($R\varphi$)
 - measure curvature for p_T

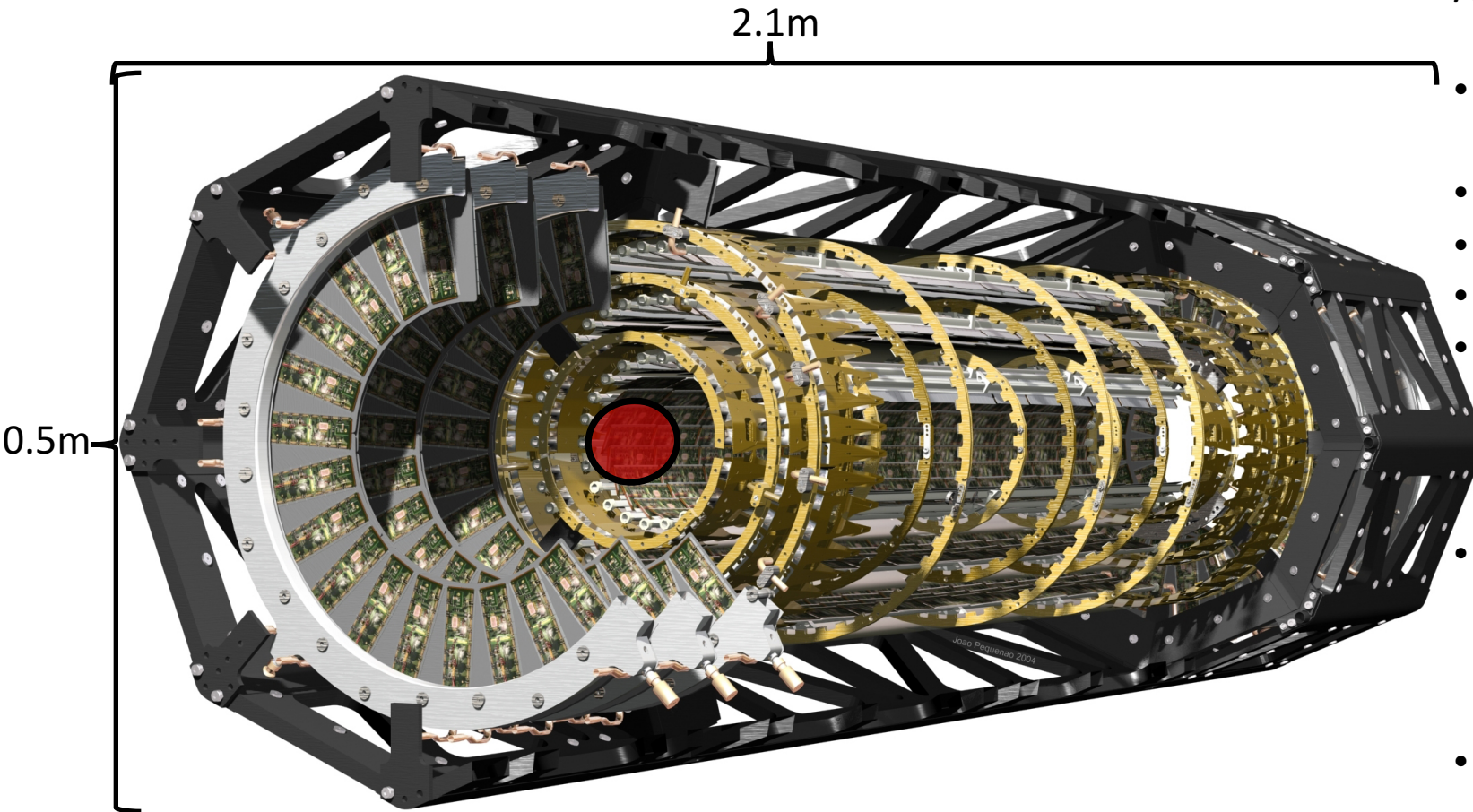


ATLAS Pixel Detector



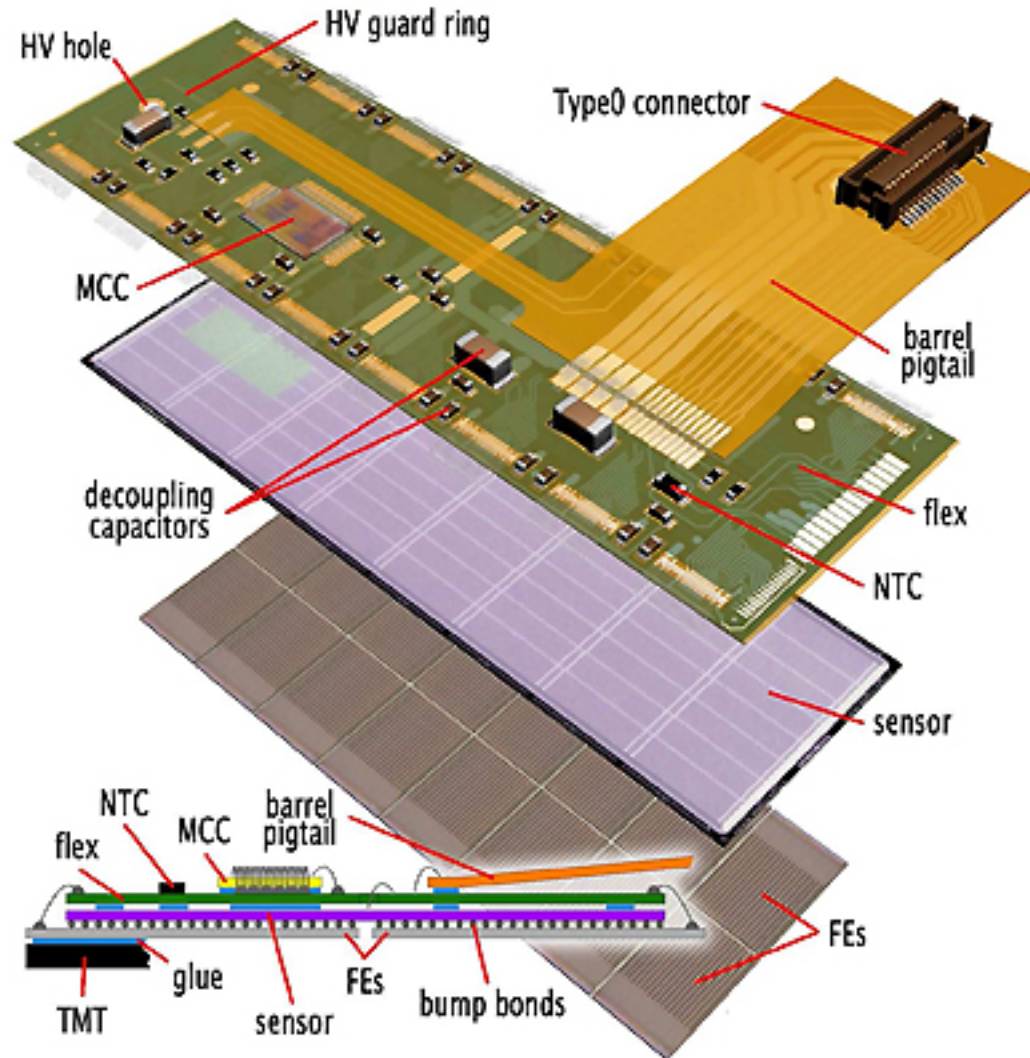
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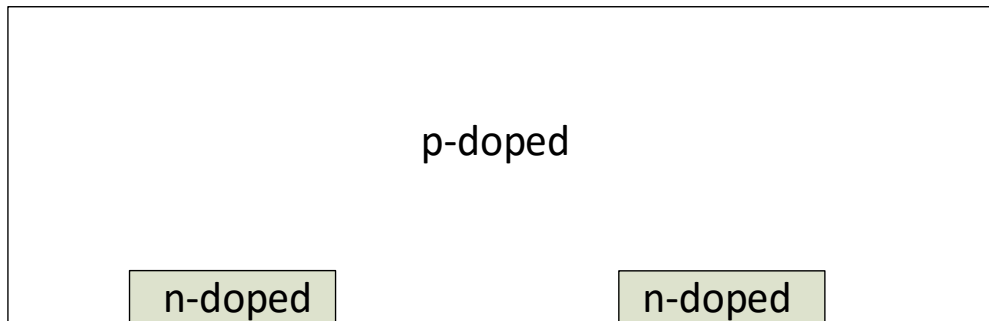
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Semiconductor Pixel Detector

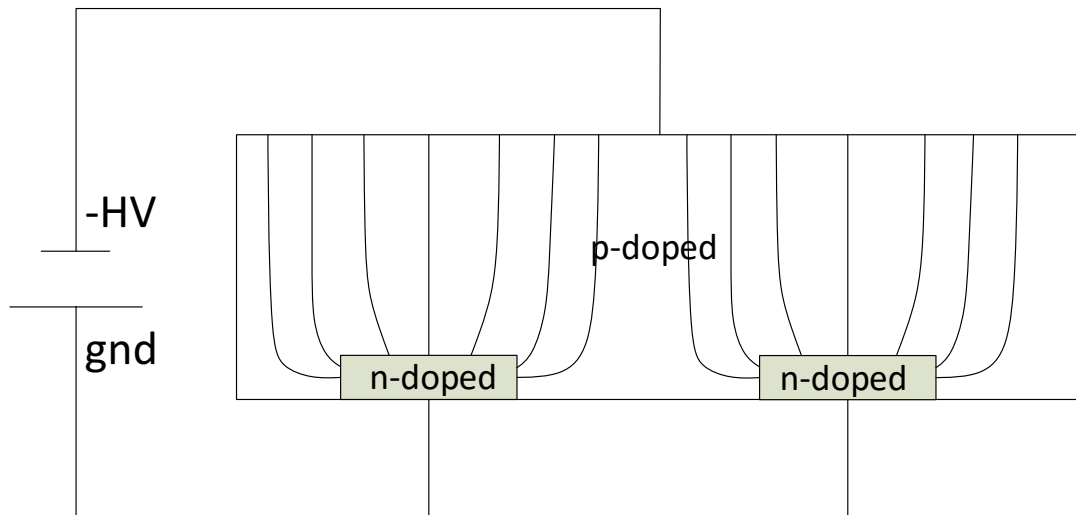


sensor

Silicon sensor:

- n-type electrode
 - collection of electrons (fast)
- typically high purity (high resistivity) bulk material
- current ATLAS technology: n-in-n
- next generation sensor technology: p-type substrate
 - available in industry
 - potential cost reduction

Semiconductor Pixel Detector

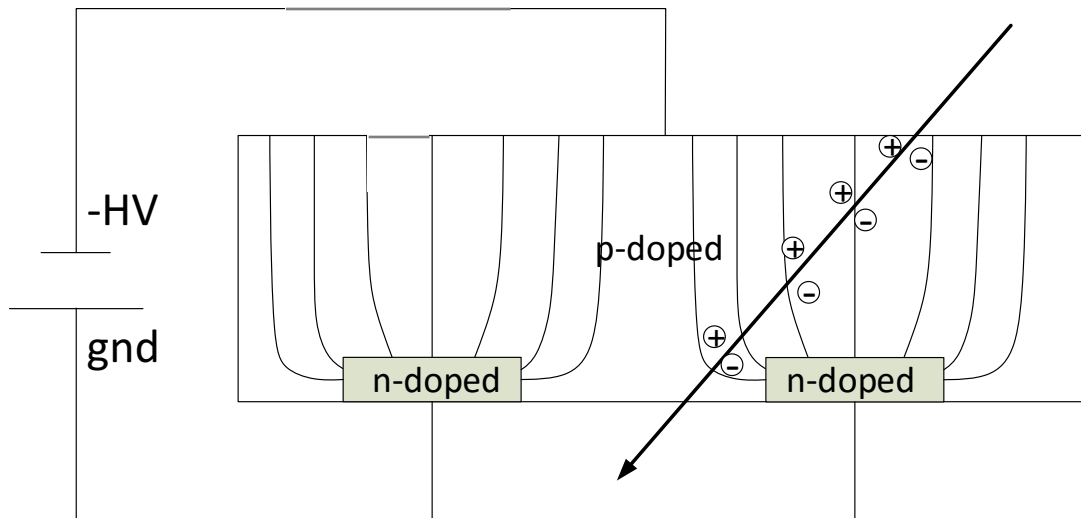


sensor

Detection mechanism:

- apply high bias voltage in reverse direction
- E-field builds up from junction to backside
- E-field collects all free charge carriers
 - $U_{\text{bias}} > U_{\text{depl}}$

Semiconductor Pixel Detector

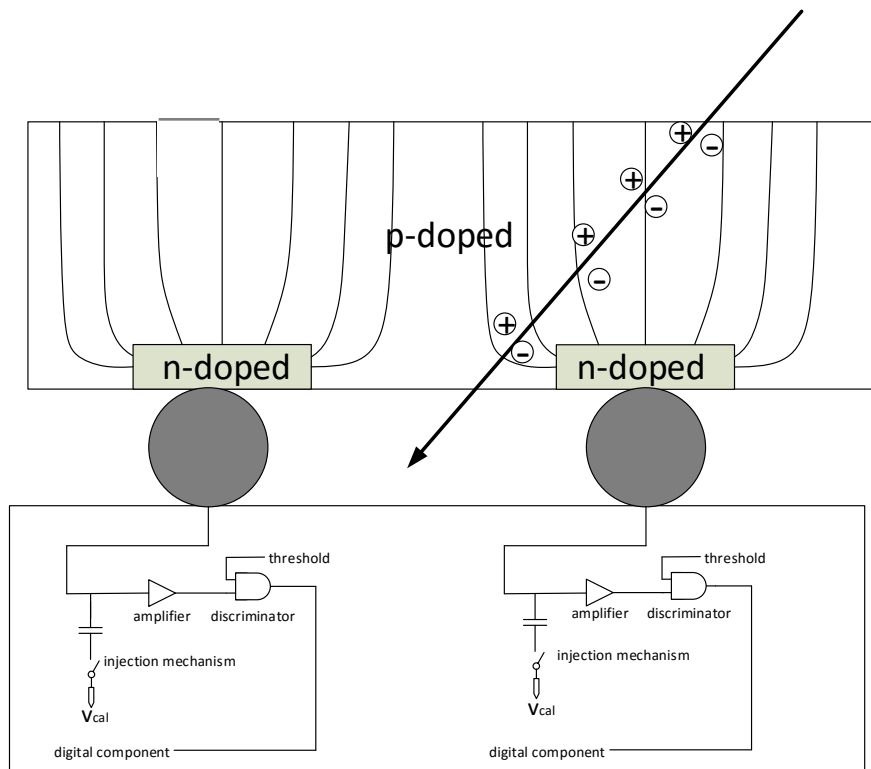


sensor

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- charged particles generate electron/hole pairs
- electrons move towards the electrode and induce a signal

Semiconductor Hybrid Pixel Detector



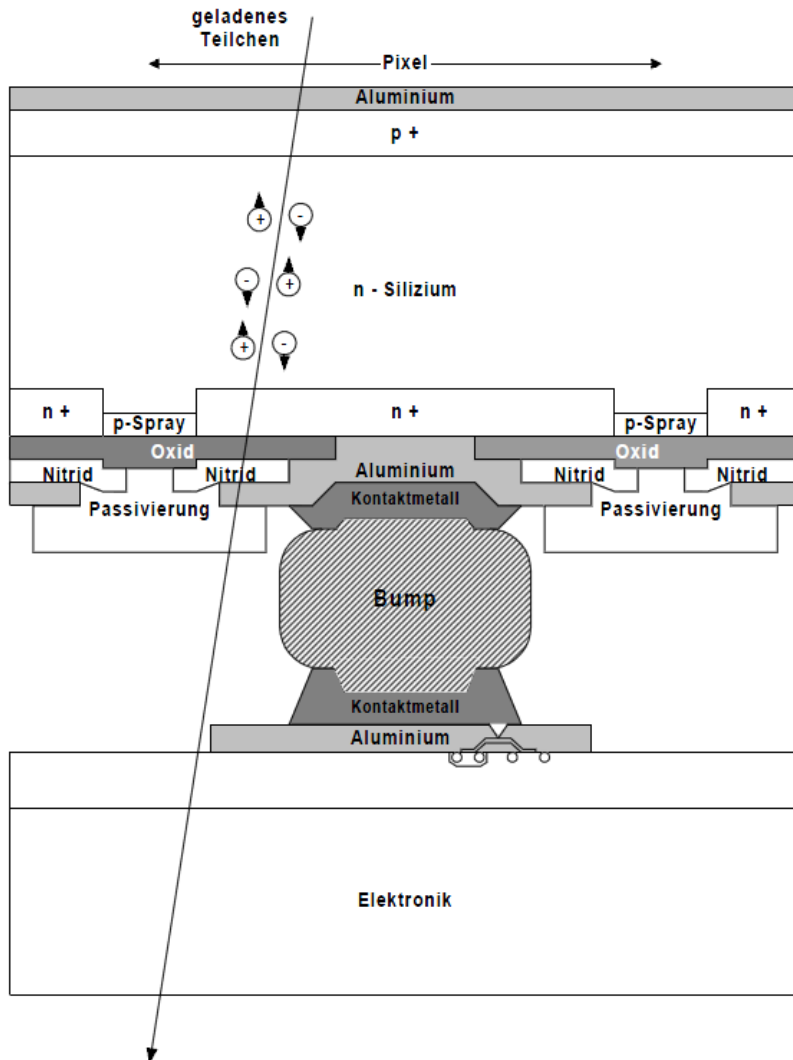
sensor

front-end

Detection mechanism:

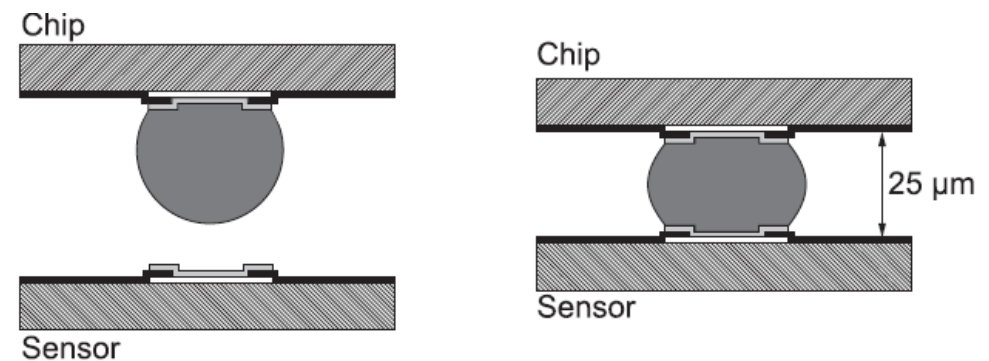
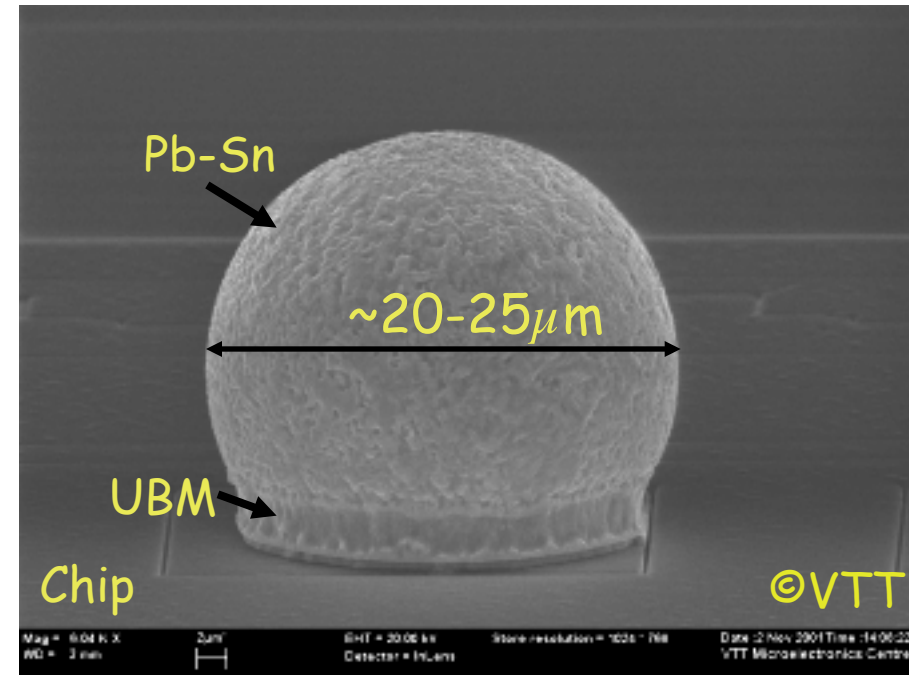
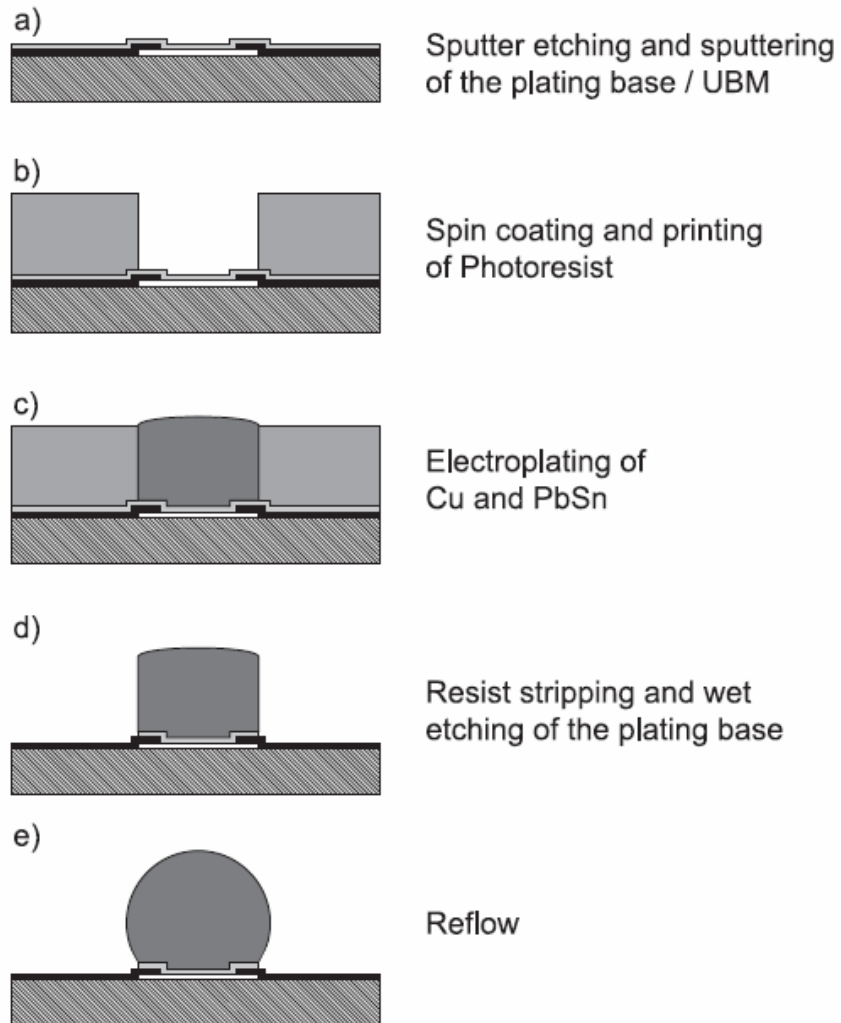
- apply high voltage in reverse direction
- E-field builds up from junction to backside
- E-field collects all free charge carriers
 - $U_{\text{bias}} > U_{\text{depl}}$
- charged particles generate electron/hole pairs
- electrons move towards the electrode and induce a signal
- signal is read-out via an attached front-end chip
 - -> hybrid pixel detector

Hybrid Pixel Detectors



- hybrid pixel detectors are composed of sensor and read-out chip connected by solder bump-bonds
 - monolithic pixel detectors combine read-out and sensor in one chip
 - hybrid approach is most powerful in terms of speed and radiation tolerance
-
- ATLAS uses hybrid pixel detectors only:
 - PIXEL: $400 \times 50 \mu\text{m}^2$ pixel size, n-in-n
 - IBL: $250 \times 50 \mu\text{m}^2$ pixel size, n-in-n

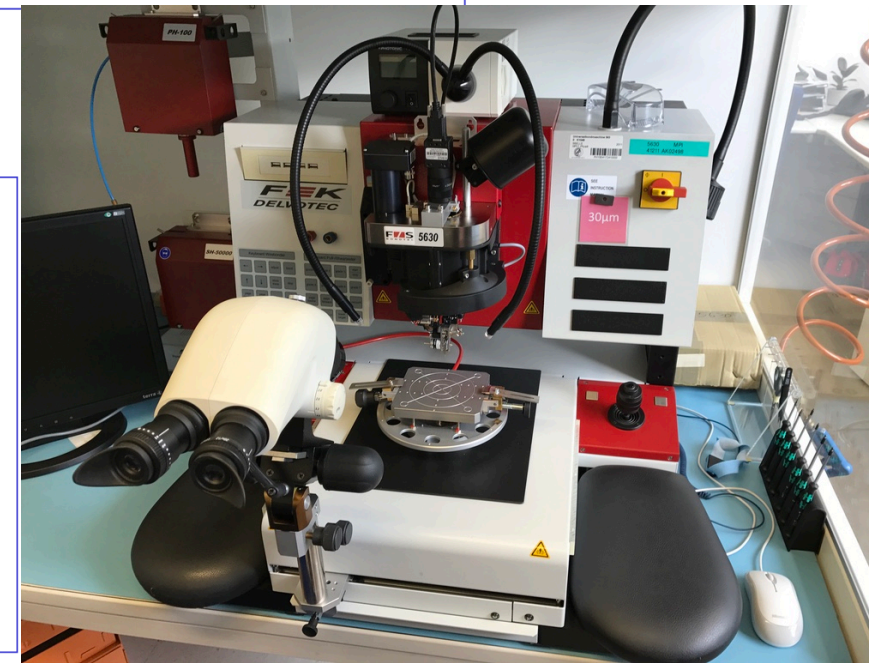
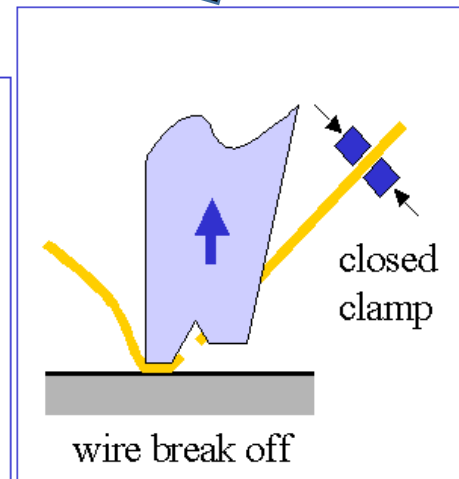
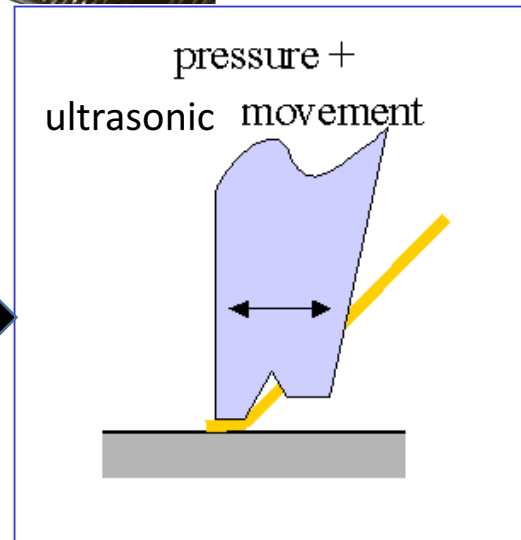
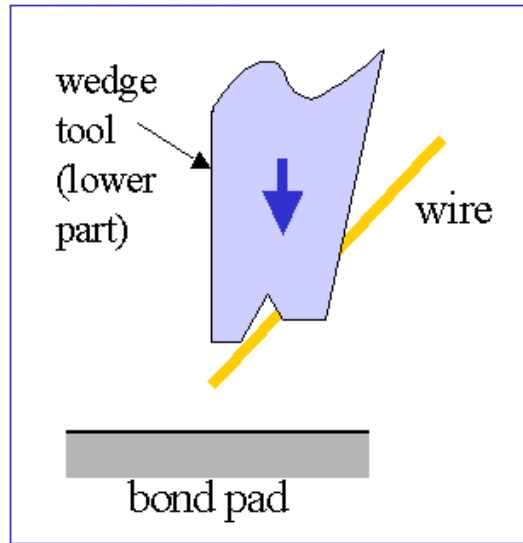
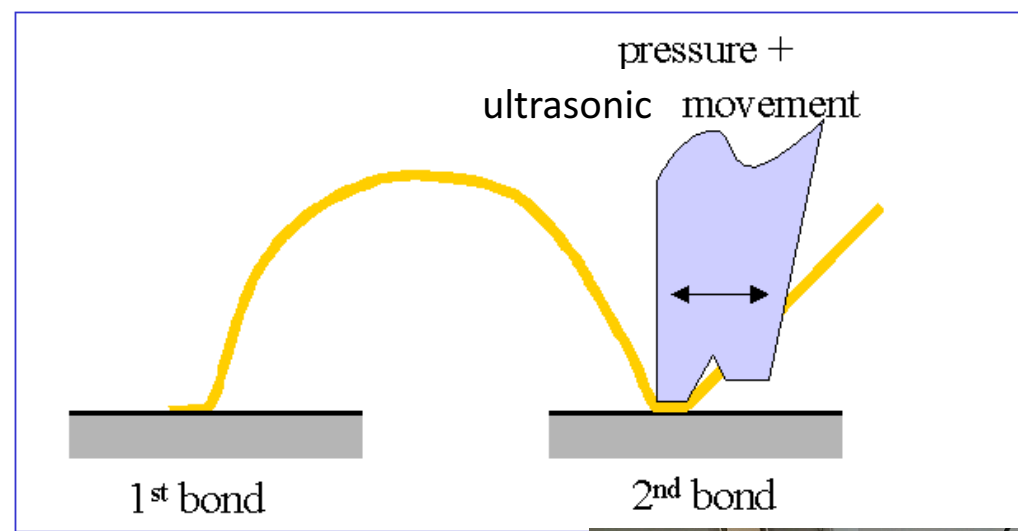
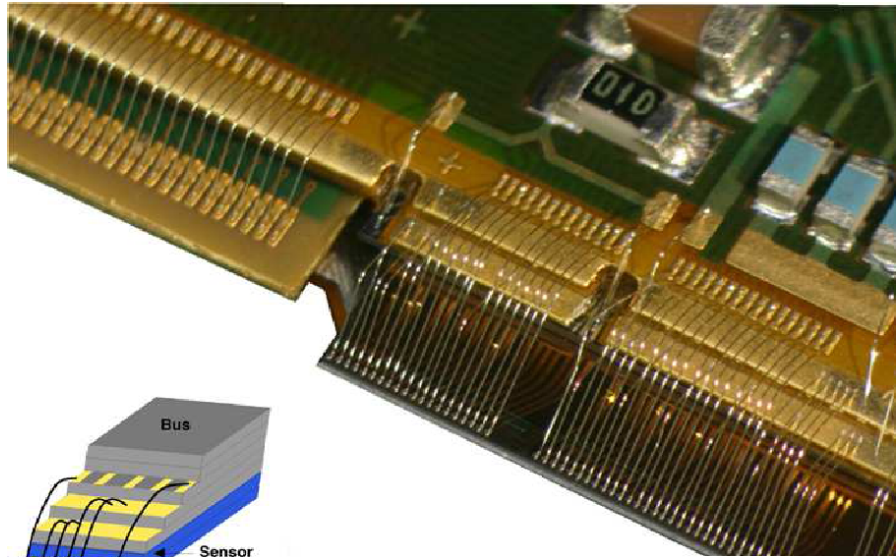
Solder Bump-Bonds



Wire Bonds



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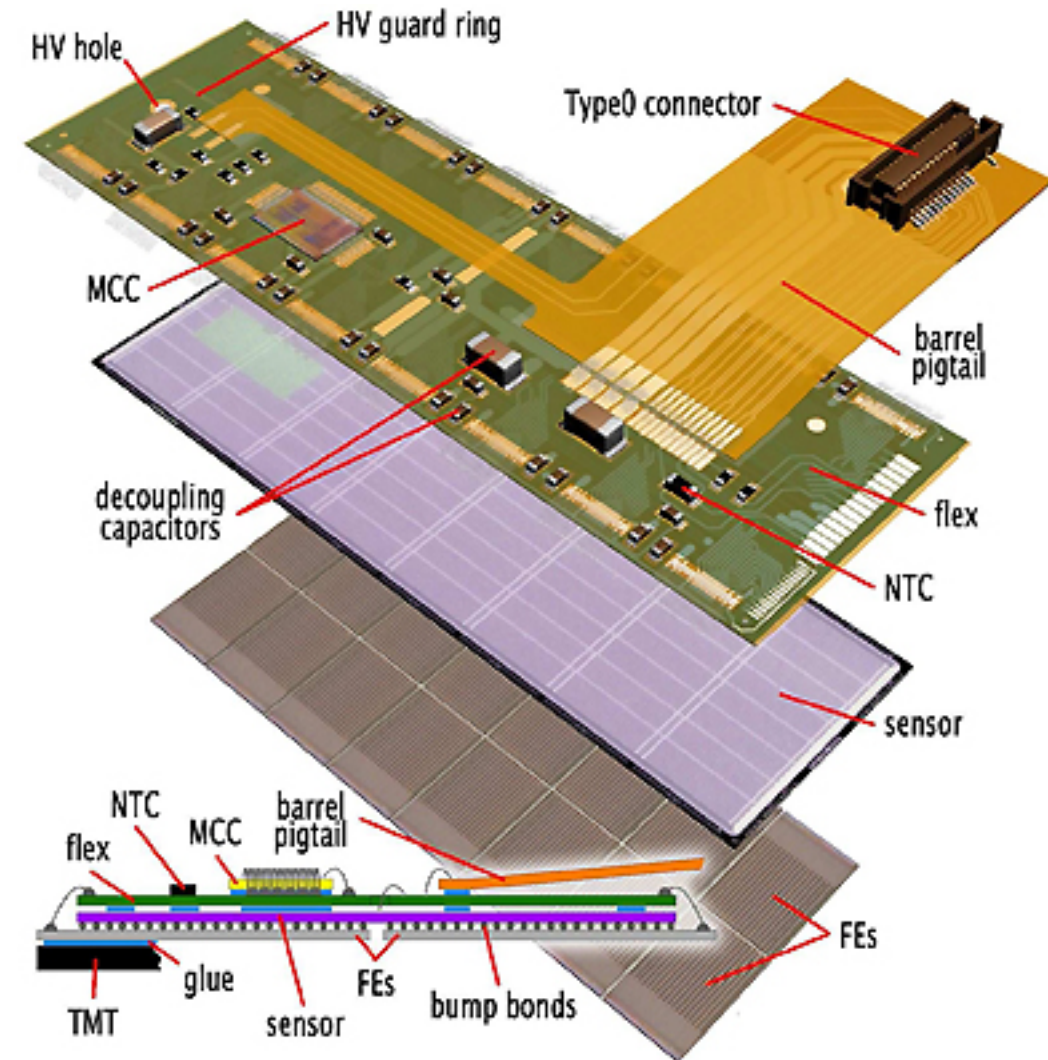
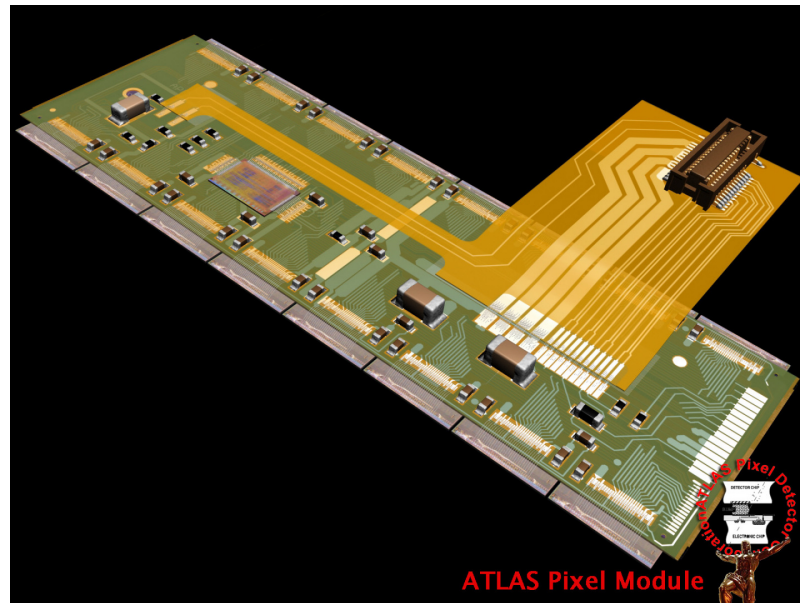
Wire bonds are necessary to transmit:

- data and control signals
- power

ATLAS Pixel Modules

Components:

- 1 sensor
- 16 FE chips
- flex circuit print
- module controller chip (MCC)



ATLAS Strip Detector

ATLAS SCT

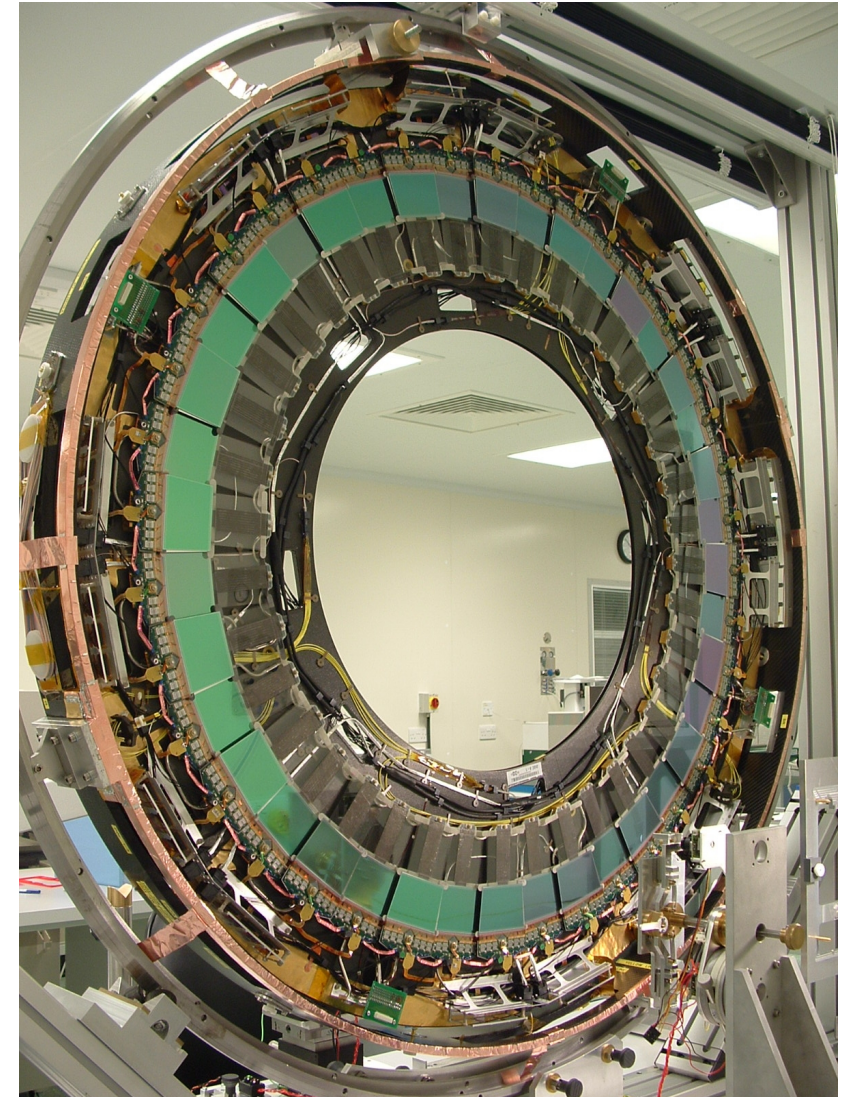
- double-sided modules
- 6.3M channels
- 16 μm resolution in $R\phi$ and 580 μm in z

- 4 barrel layers
 - 80 μm pitch strips
- 9 disks per side
 - 70-90 μm pitch strips

- 30% of disk modules produced at MPP!

Function:

- cover large area (61.1m²)
- best compromise of cost and precision

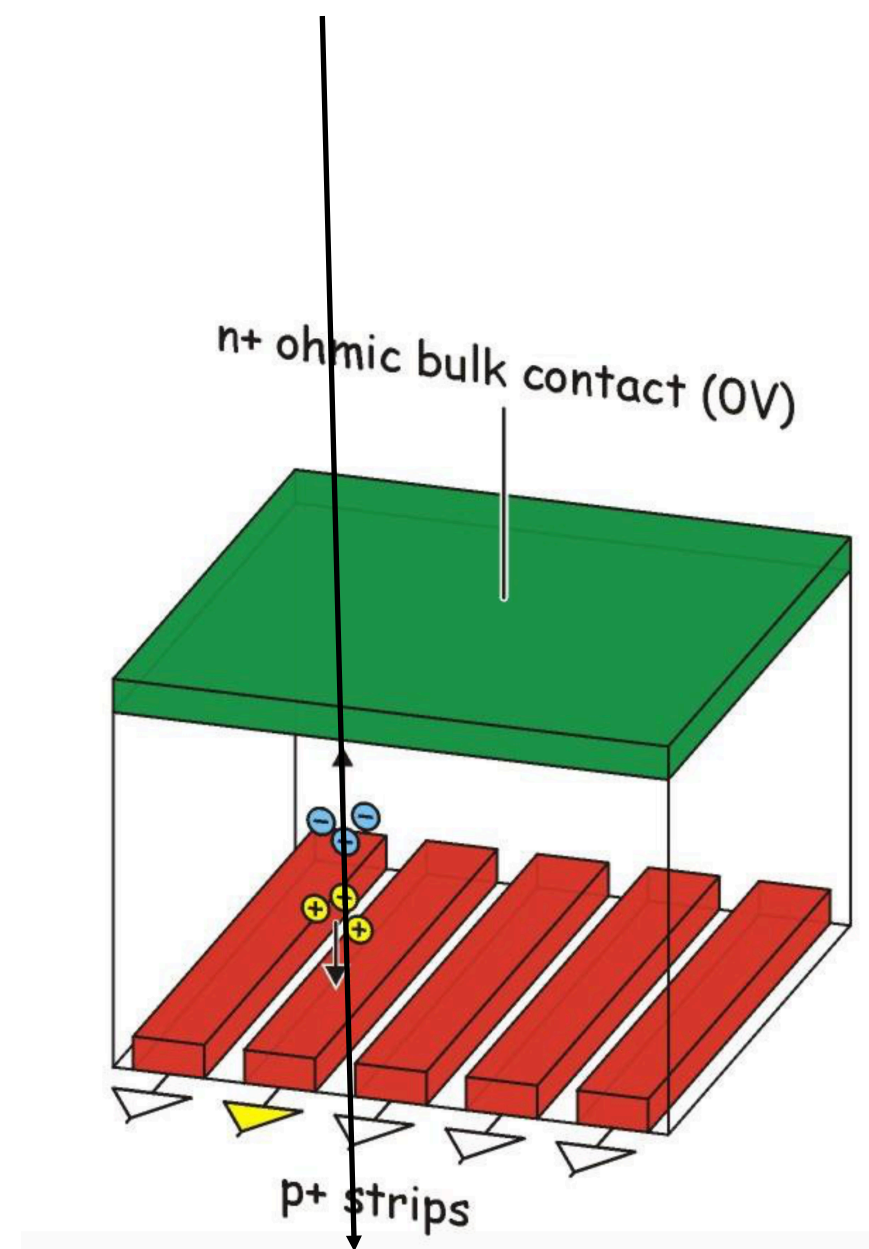


Strip Detector



Working principle:

- strip detector is pixel detector with long pixels
 - resolution in one direction bit worse
 - resolution in other direction much worse
- only 1D information given!
- read-out each single strip



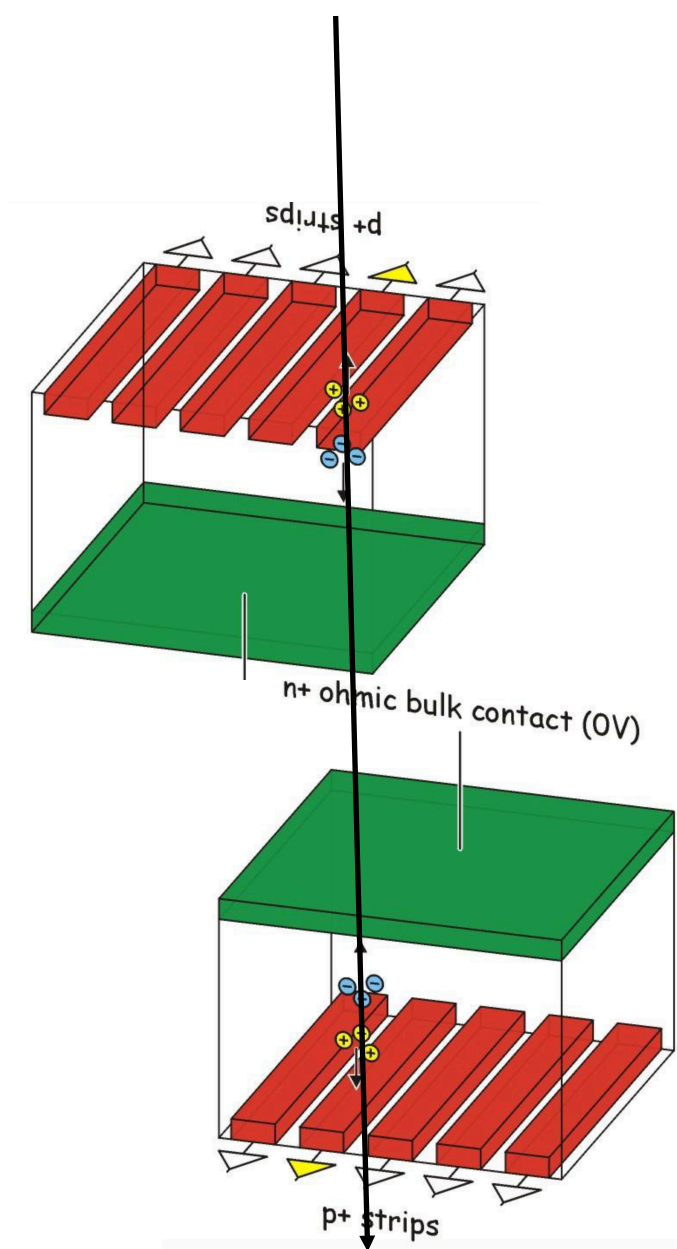
Strip Detector

Working principle:

- strip detector is pixel detector with long pixels
 - resolution in one direction bit worse
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Improvements:

- use another rotated sensor on top
- ATLAS uses rotation angle of 40 mrad
- 2D information by combination



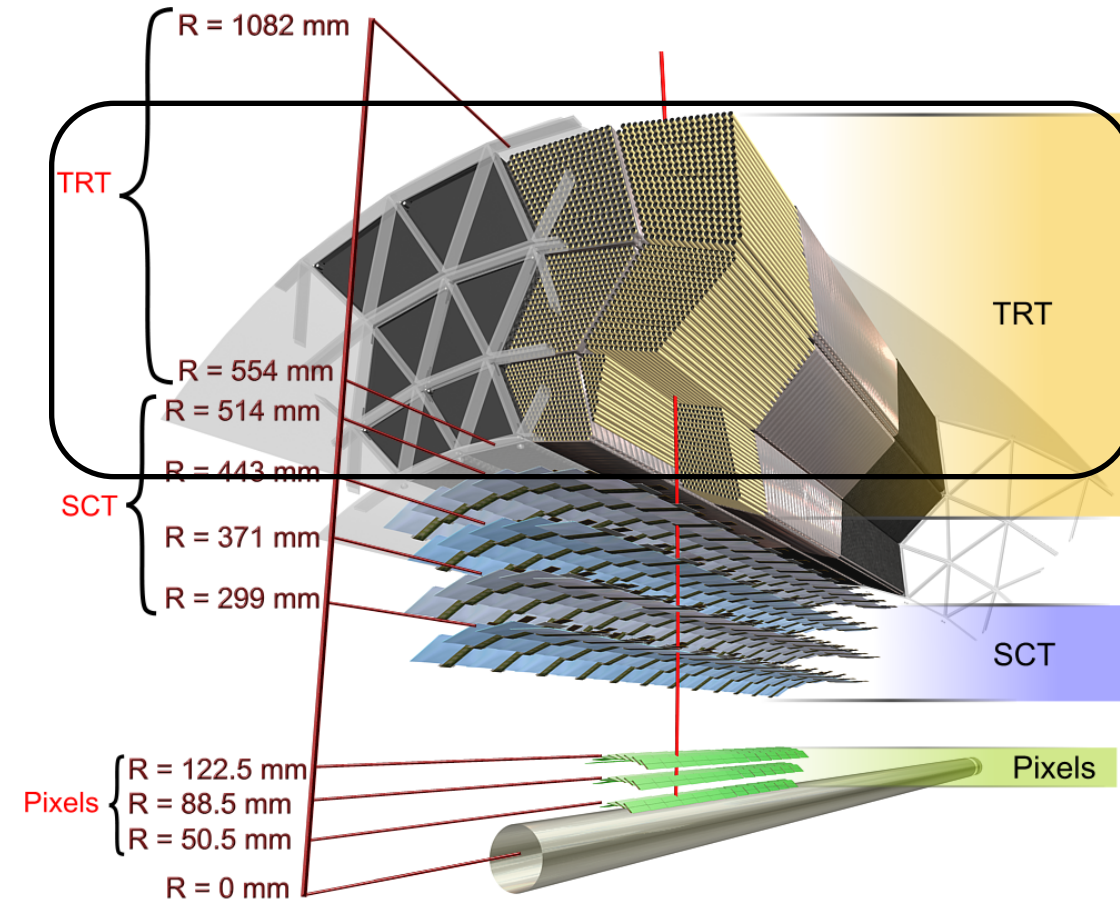
ATLAS Transition Radiation Tracker

ATLAS TRT

- separated into barrel and disks
- barrel with straws parallel to beam
- disks with straws perpendicular to beam
- 400k channels
- straws have diameter of 4mm
- 170 μm resolution in $R\phi$, 40-75cm length

Function:

- provide tracking at large radii
- particle identification via TR
- trigger information
- best cost-effectiveness



Transition Radiation Detector

Theory:

- charged particles emit gamma radiation (x-ray energies) when entering a different media

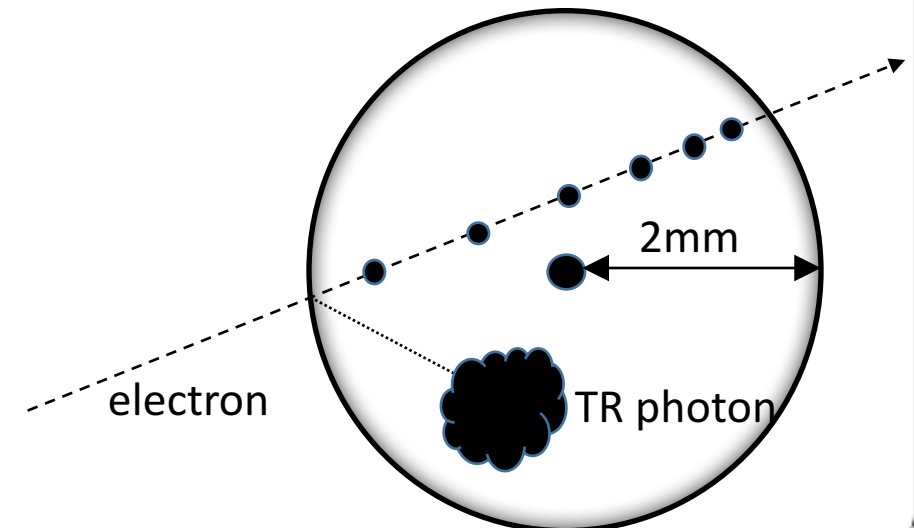
- intensity given by
$$I = \frac{\gamma q^2 (\omega_1 - \omega_2)^2}{3c}$$

- with
$$\gamma = \frac{E}{mc^2}$$

- mass of a particle can be calculated for known energy
- used here for electron/hadron identification

Experiment:

- thin straw tubes with anode wire as proportional counter
- two threshold read-out
 1. low threshold for ionization
 2. high threshold for TR-photons

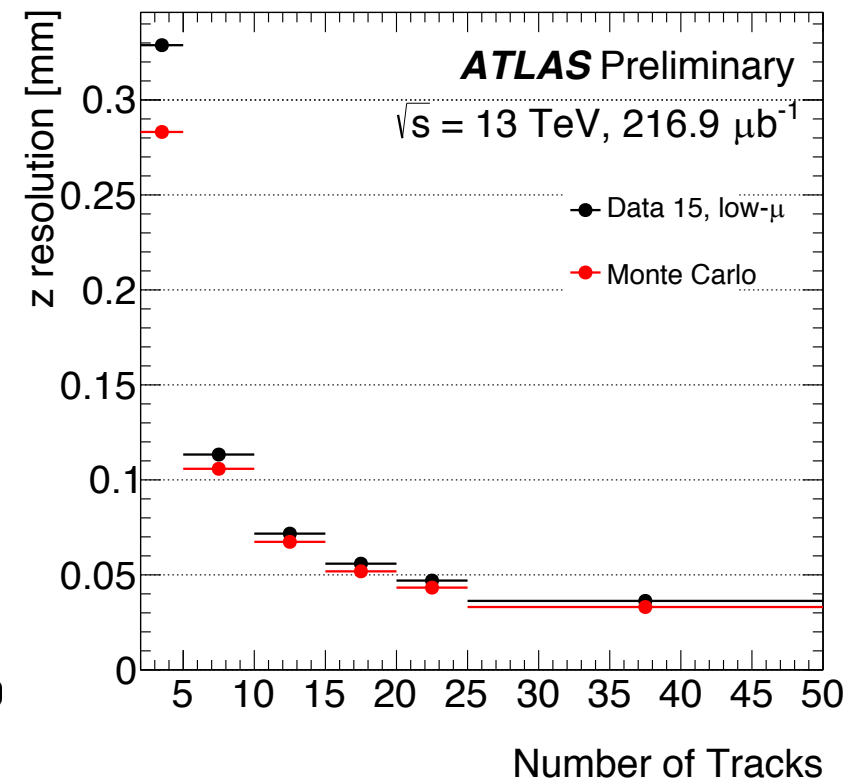
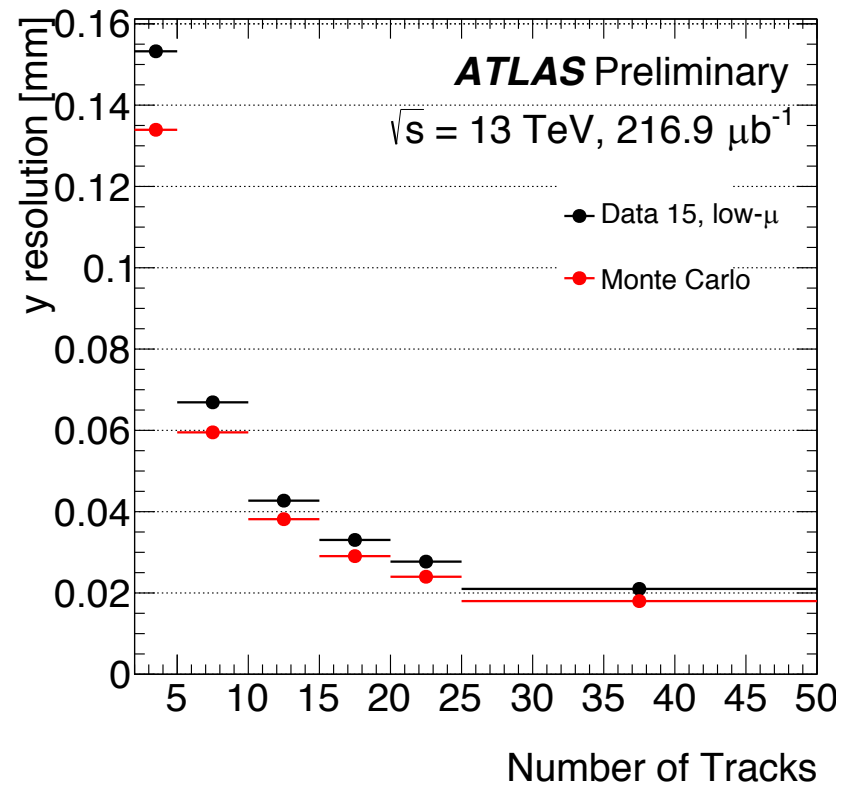
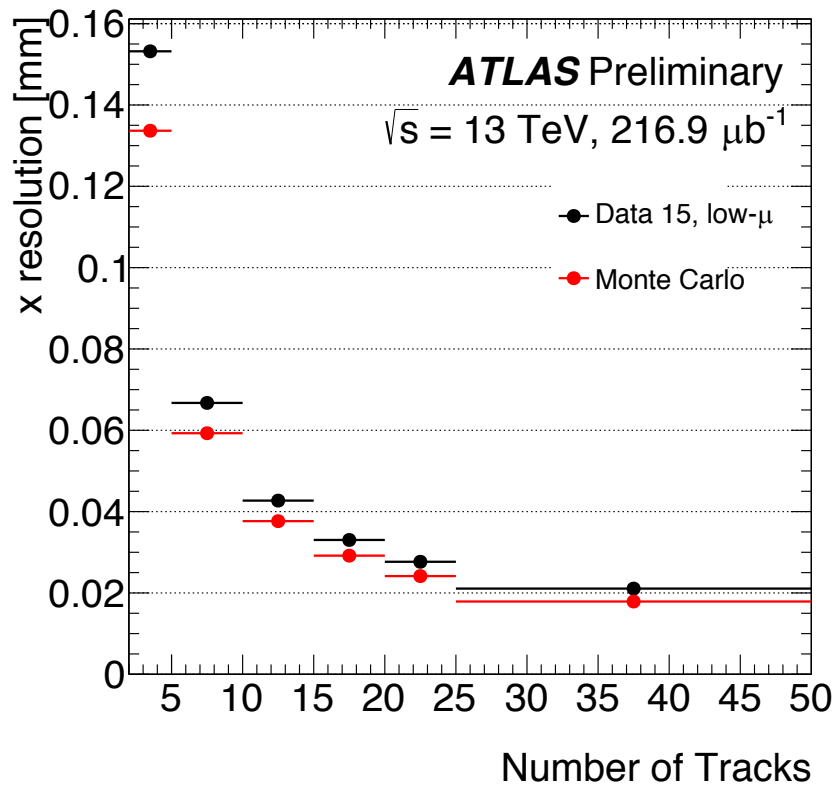


ATLAS ID Performance

Primary vertex resolution

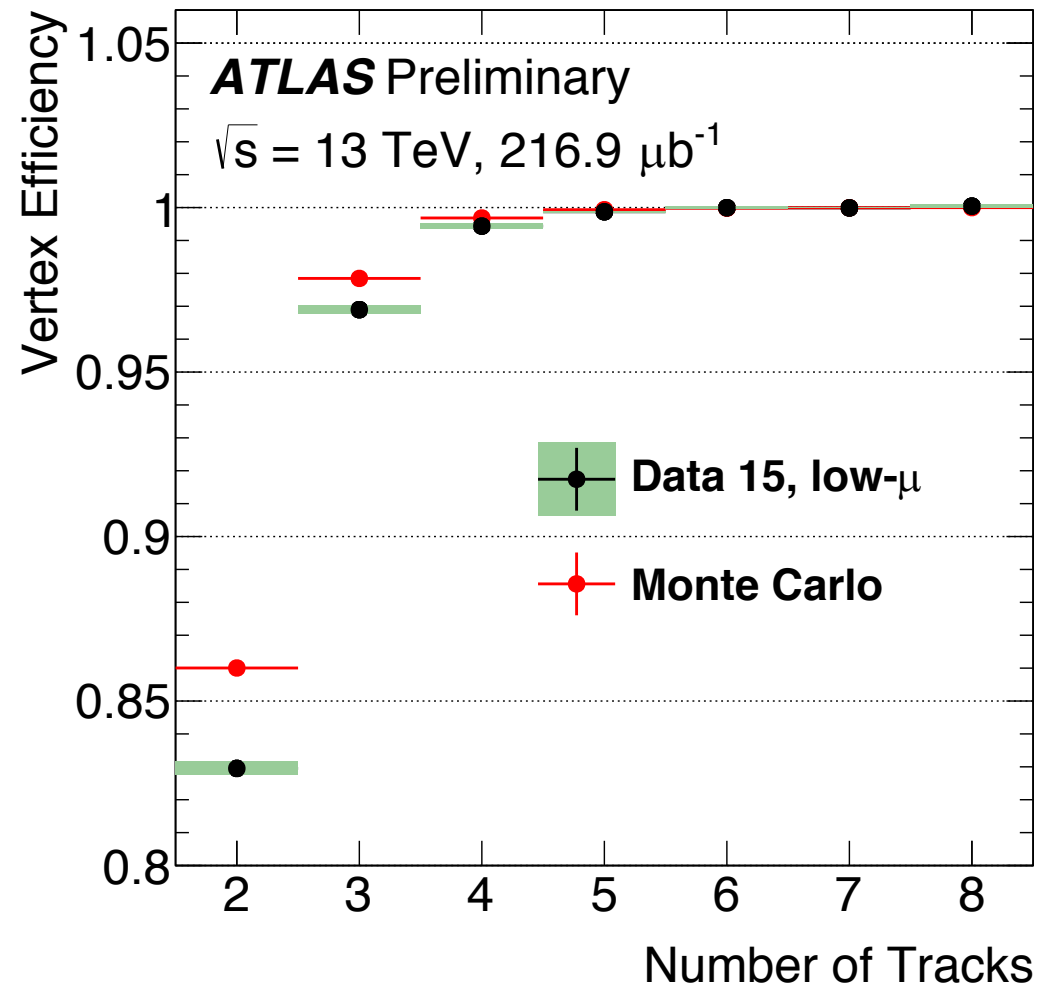


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ATLAS ID Performance

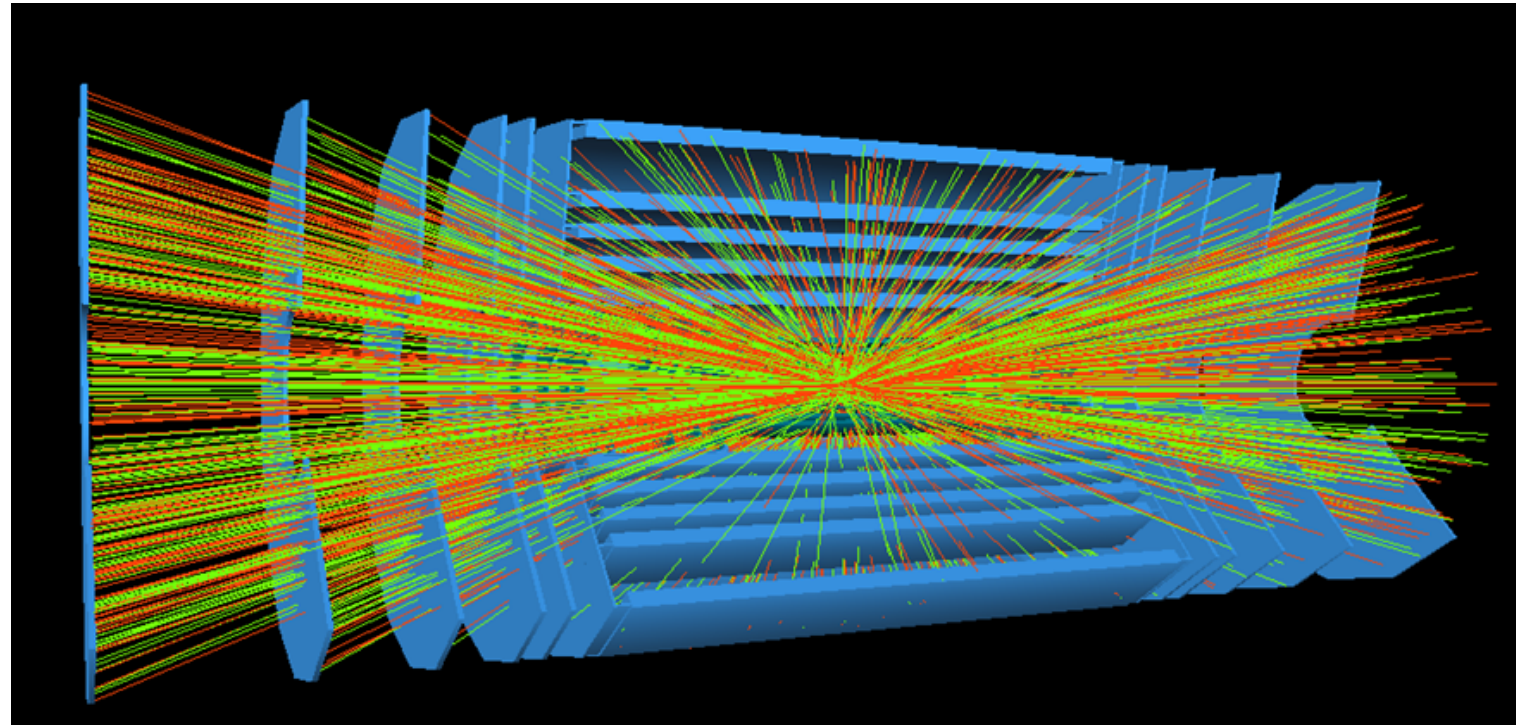
Vertex reconstruction efficiency



ATLAS Inner Tracker (ITk) Upgrade

ITk:

- new tracking system facing HL-LHC
- concept foresees all silicon detector
 - 5 pixel layers
 - 4 strip layers
- main challenges
 - increased occupancy
 - $\langle\mu\rangle=24 \rightarrow \langle\mu\rangle=200$
 - more radiation damage
 - $5e15 \text{ n}_{eq}/\text{cm}^2 \rightarrow 14e15 \text{ n}_{eq}/\text{cm}^2$



Conclusion



Inner Detector:

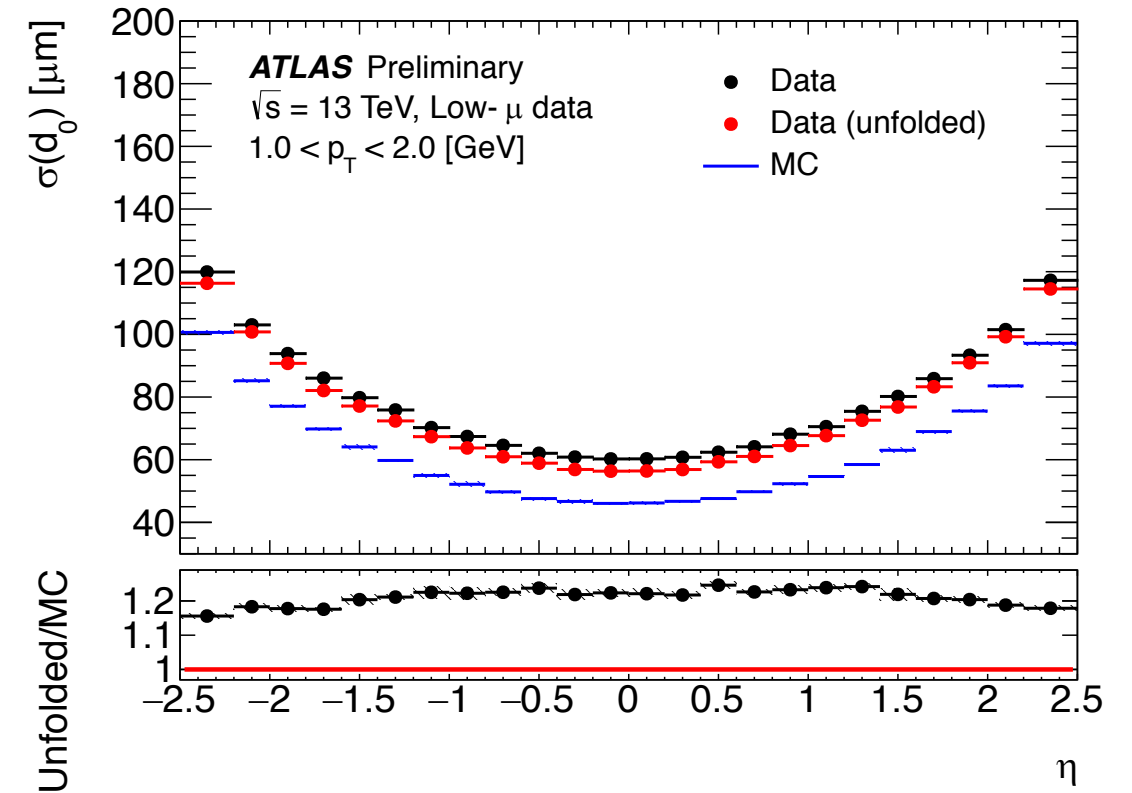
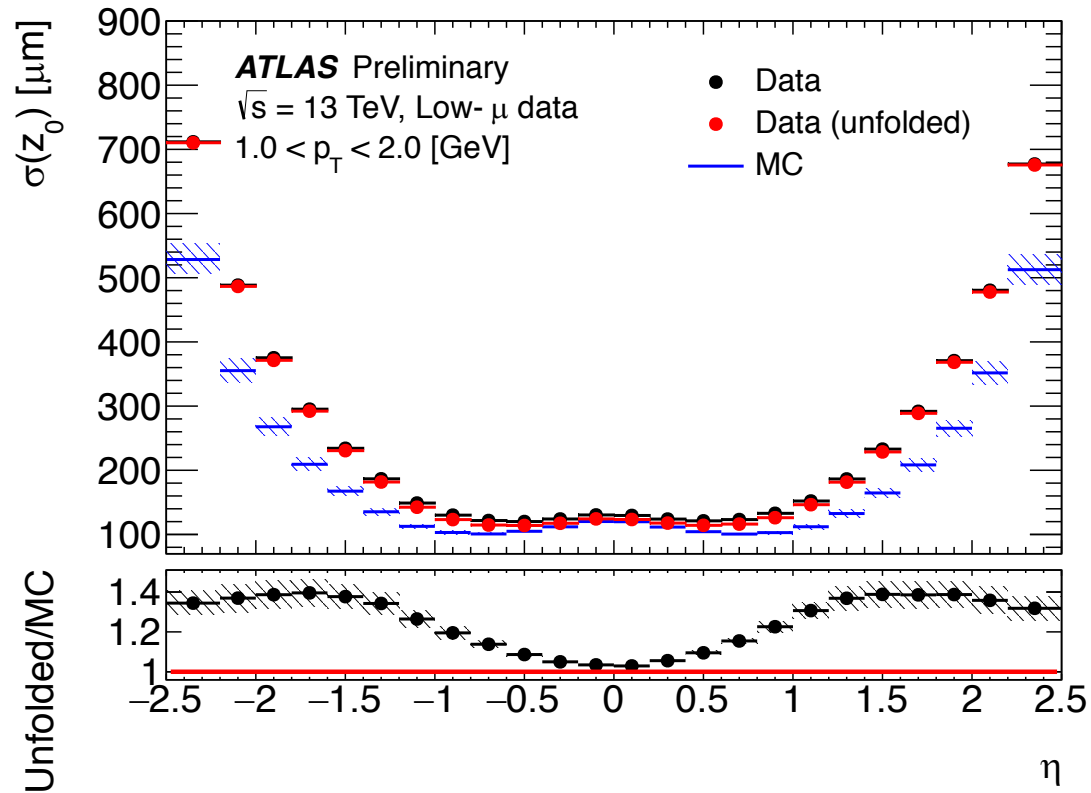
- composed of
 - Pixel Detector
 - Strip Detector
 - Transition Radiation Tracker
- used for
 - precise tracking (including (secondary) vertex finding, impact parameter, p_T , ...)
 - particle identification
- reaches primary vertex resolution of $20 \mu\text{m} / 20 \mu\text{m} / 50 \mu\text{m}$ (x/y/z)
- will be replaced by the ITk

	$R\phi$ – Resolution [μm]	z – Resolution [μm]
PD	10	110
SCT	16	580
TRT	170	750.000-1.500.000

Thank you for your attention!

ATLAS ID Performance

Impact parameter resolution



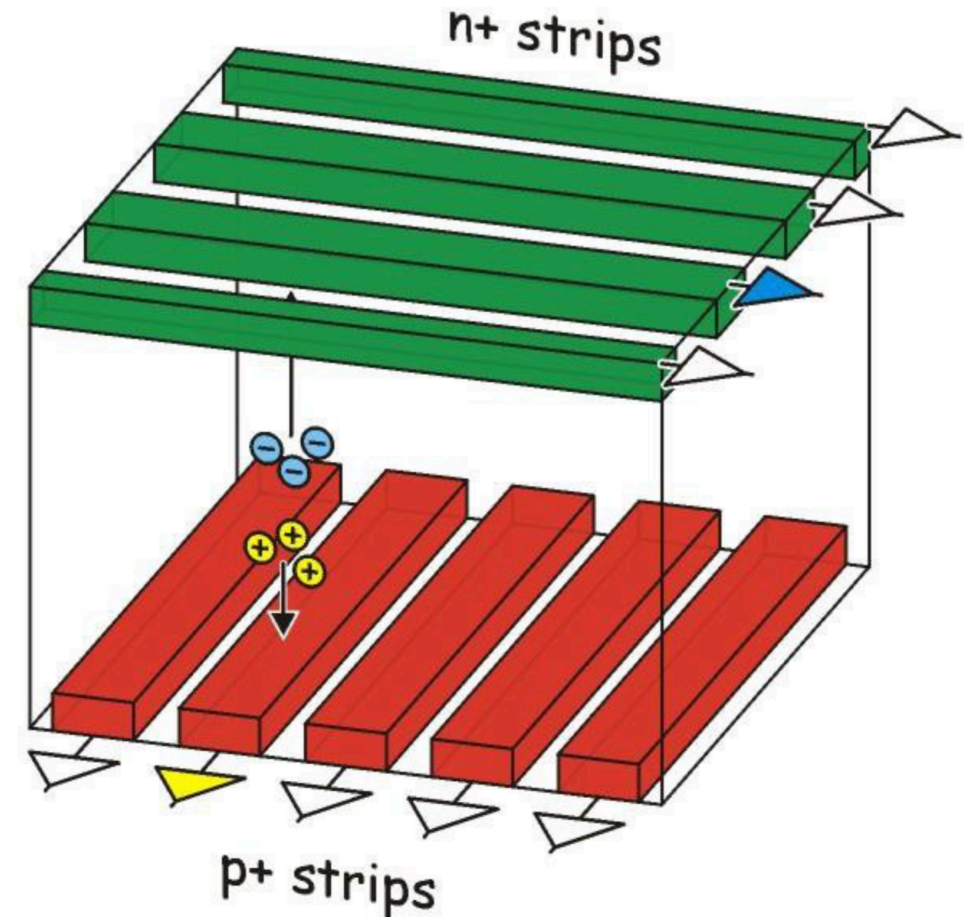
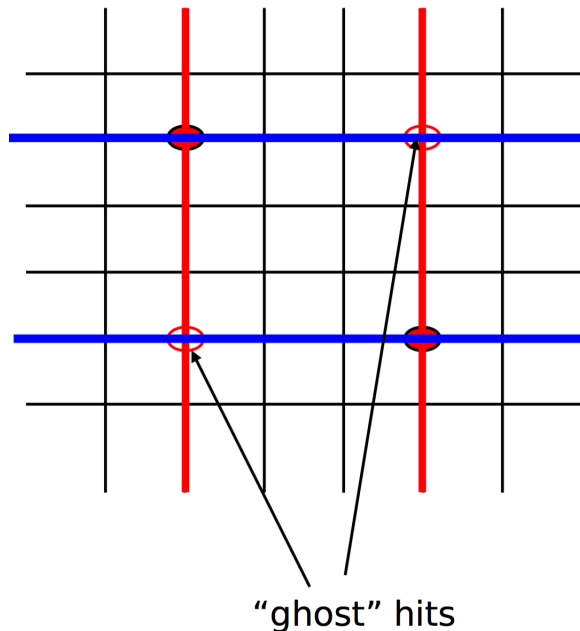
Silicon Strip Detector

Working principle:

- one segmented side / one homogeneous side
- read-out each single strip
- no 2D information given!

Improvements:

- segment both sides and tilt them (ATLAS: 40mrad)
- 2D information is given, but





Transition Radiation Detector

Straw tubes:

- straw tubes are operated as proportional counters
- anode is 31 μm thin gold-plated tungsten wire
- cathode is tube
 - 60 μm multilayer film of carbon-polyimide-aluminium-Kapton-polyurethan
- Xe-CO₂-O₂ (70-27-3) gas used to convert TR x-ray photons and to create free charge carriers by penetrating ionizing particles

ATLAS Pixel Detector



Necessary Resolution:

- low along the beam pipe
 - straight line
- high in bended direction
 - measure curvature for p_T

